Power Field Effect Transistor DPAK for Surface Mount N-Channel Enhancement-Mode Silicon Gate

This Power FET is designed for high speed, low loss power switching applications such as switching regulators, converters, solenoid and relay drivers.

Features

- Silicon Gate for Fast Switching Speeds
- Low $R_{DS(on)} 0.3 \Omega$ Max
- Rugged SOA is Power Dissipation Limited
- Source-to-Drain Diode Characterized for Use With Inductive Loads
- Low Drive Requirement V_{GS(th)} = 4.0 V Max
- Surface Mount Package on 16 mm Tape
- Pb-Free Package is Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	150	Vdc
Drain–Gate Voltage (R_{GS} = 1.0 M Ω)	V _{DGR}	150	Vdc
$\begin{array}{l} \mbox{Gate-Source Voltage} \\ \mbox{- Continuous} \\ \mbox{- Non-Repetitive } (t_p \leq 50 \ \mu s) \end{array}$	V _{GS} V _{GSM}	± 20 ± 40	Vdc Vpk
Drain Current – Continuous – Pulsed	I _D I _{DM}	6.0 20	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	20 0.16	W W/°C
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above 25°C (Note 1)	P _D	1.25 0.01	W W/°C
Total Power Dissipation @ T _A = 25°C (Note 1) Derate above 25°C (Note 2)	P _D	1.75 0.014	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance – Junction-to-Case – Junction-to-Ambient (Note 1) – Junction-to-Ambient (Note 2)	$f{R}_{ heta JC} \ f{R}_{ heta JA} \ f{R}_{ heta JA}$	6.25 100 71.4	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. When surface mounted to an FR4 board using the minimum recommended pad size.

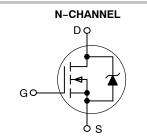
2. When surface mounted to an FR4 board using 0.5 sq. in. drain pad size.



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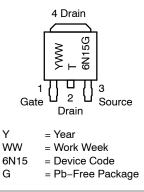
V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
150 V	0.3 Ω	6.0 A





DPAK (Surface Mount) STYLE 2

MARKING DIAGRAM & PIN ASSIGNMENTS



ORDERING INFORMATION

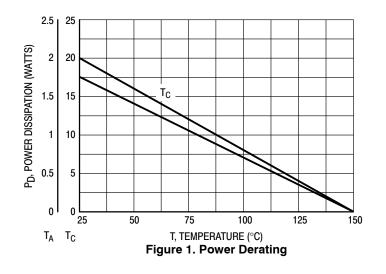
Device	Package	Shipping [†]
MTD6N15T4	DPAK	2500/Tape & Reel
MTD6N15T4G	DPAK (Pb-Free)	2500/Tape & Reel

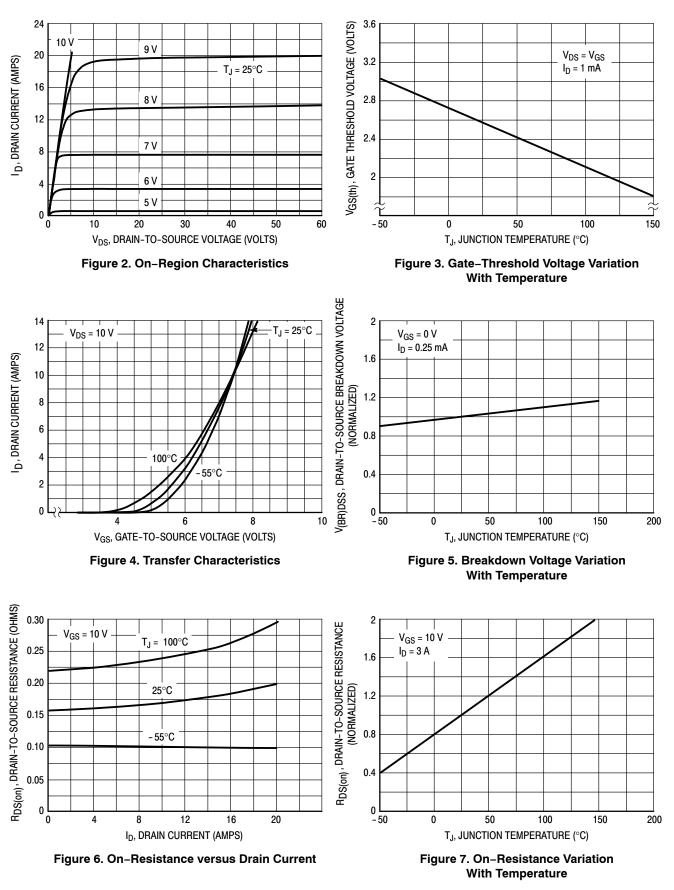
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

Characteristic			Min	Max	Unit
OFF CHARACTERISTICS			1	•	
Drain–Source Breakdown Voltage (V_{GS} = 0 Vdc, I_D = 0.25 mAdc)		V _{(BR)DSS}	150	-	Vdc
Zero Gate Voltage Drain Current (V_{DS} = Rated V_{DSS} , V_{GS} = 0 Vdc) T_J = 125°C		I _{DSS}		10 100	μAdc
Gate-Body Leakage Current, Forward	d (V _{GSF} = 20 Vdc, V _{DS} = 0)	I _{GSSF}	_	100	nAdc
Gate-Body Leakage Current, Reverse	e (V _{GSR} = 20 Vdc, V _{DS} = 0)	I _{GSSR}	-	100	nAdc
ON CHARACTERISTICS (Note 3)			1	•	
Gate Threshold Voltage (V_{DS} = V_{GS}, T_J = 100^{\circ}C	_D = 1.0 mAdc)	V _{GS(th)}	2.0 1.5	4.5 4.0	Vdc
Static Drain-Source On-Resistance (V _{GS} = 10 Vdc, I _D = 3.0 Adc)	R _{DS(on)}	-	0.3	Ω
Drain–Source On–Voltage (V _{GS} = 10 Vdc) (I_D = 6.0 Adc) (I_D = 3.0 Adc, T_J = 100°C)				1.8 1.5	Vdc
Forward Transconductance (V _{DS} = 15	5 Vdc, I _D = 3.0 Adc)	9 FS	2.5	-	mhos
DYNAMIC CHARACTERISTICS			1	•	
Input Capacitance		C _{iss}	-	1200	pF
Output Capacitance	(V _{DS} = 25 Vdc, V _{GS} = 0 Vdc, f = 1.0 MHz) (See Figure 11)	C _{oss}	_	500	
Reverse Transfer Capacitance		C _{rss}	-	120	
SWITCHING CHARACTERISTICS* (T _J = 100°C)				
Turn-On Delay Time		t _{d(on)}	-	50	ns
Rise Time	(V _{DD} = 25 Vdc, I _D = 3.0 Adc, R _G = 50 Ω)	t _r	-	180	
Turn-Off Delay Time	(See Figures 13 and 14)	t _{d(off)}	-	200	
Fall Time		t _f	-	100	
Total Gate Charge	(V _{DS} = 0.8 Rated V _{DSS} ,	Qg	15 (Typ)	30	nC
Gate-Source Charge	I _D = Rated I _D , V _{GS} = 10 Vdc)	Q _{gs}	8.0 (Typ)	-	
Gate-Drain Charge	(See Figure 12)	Q _{gd}	7.0 (Typ)	-	
SOURCE-DRAIN DIODE CHARACT	ERISTICS*				
Forward On-Voltage		V _{SD}	1.3 (Typ)	2.0	Vdc
Forward Turn-On Time	$(I_S = 6.0 \text{ Adc}, \text{ di/dt} = 25 \text{ A/}\mu\text{s}, \text{ V}_{GS} = 0 \text{ Vdc})$	t _{on}	Limited by stray inductanc		uctance
Reverse Recovery Time	7	t _{rr}	325 (Typ)	_	ns

3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.





TYPICAL ELECTRICAL CHARACTERISTICS

SAFE OPERATING AREA

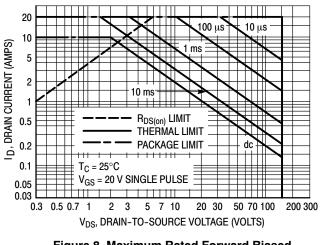
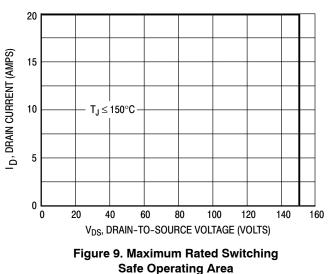


Figure 8. Maximum Rated Forward Biased Safe Operating Area



oure operating Area

SWITCHING SAFE OPERATING AREA

FORWARD BIASED SAFE OPERATING AREA

The FBSOA curves define the maximum drain-to-source voltage and drain current that a device can safely handle when it is forward biased, or when it is on, or being turned on. Because these curves include the limitations of simultaneous high voltage and high current, up to the rating of the device, they are especially useful to designers of linear systems. The curves are based on a case temperature of 25°C and a maximum junction temperature of 150°C. Limitations for repetitive pulses at various case temperatures can be determined by using the thermal response curves. Motorola Application Note, AN569, "Transient Thermal Resistance-General Data and Its Use" provides detailed instructions.

The switching safe operating area (SOA) of Figure 9 is the boundary that the load line may traverse without incurring damage to the MOSFET. The fundamental limits are the peak current, I_{DM} and the breakdown voltage, $V_{(BR)DSS}$. The switching SOA shown in Figure 8 is applicable for both turn-on and turn-off of the devices for switching times less than one microsecond.

The power averaged over a complete switching cycle must be less than:

$$\frac{T_{J(max)} - T_C}{R_{\theta JC}}$$

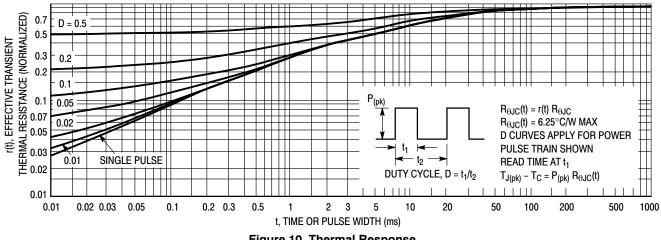


Figure 10. Thermal Response

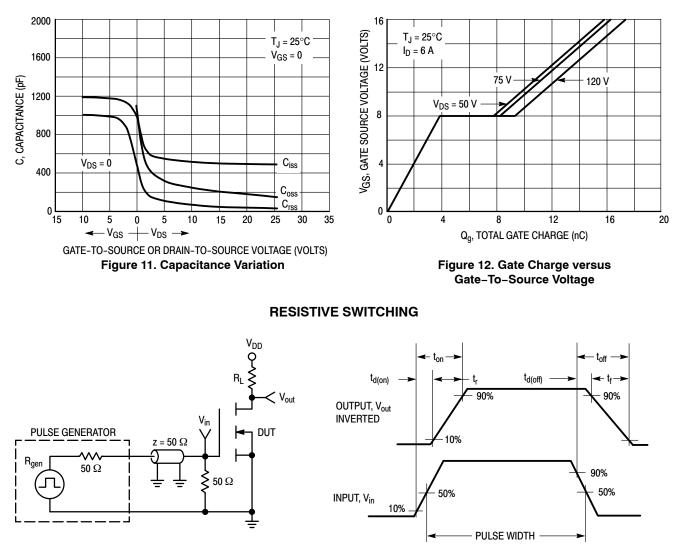
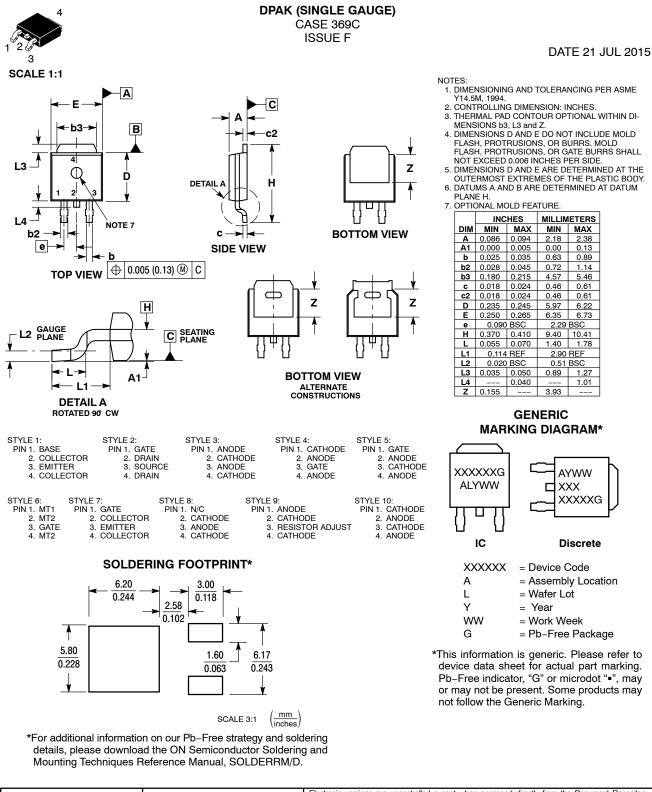


Figure 13. Switching Test Circuit

Figure 14. Switching Waveforms

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